

Part Number: 2028280506

Product Description: Mirror Mezz Hermaphroditic Connector, 2.50mm Connector Height, BGA-Attach Mounting, 6 Pair, 5 Row, 124 Circuits, 0.76µm Gold (Au)

Plating

Status: Active

Series Number: 202828

Product Category: Board-to-Board

Connectors

Documents & Resources

Drawings

Drawing 2028280506_sd.pdf

3D Models and Design Files

3D Model 2028280506_stp.zip

Electrical Model Document 2028281506EE-000.pdf

S-Parameter Model 2028281506SP-000.zip

Specifications

Application Specification 2028280001-AS-000.pdf
Application Specification 2028289005PS-001.pdf
Product Specification 2028280001-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	@
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Board-to-Board Connectors
Series	202828
Description	Mirror Mezz Hermaphroditic Connector, 2.50mm Connector Height, BGA-Attach Mounting, 6 Pair, 5 Row, 124 Circuits, 0.76µm Gold (Au) Plating
Application	Board-to-Board
Component Type	PCB Header
Product Family	Mirror Mezz Connectors
Product Name	Mirror Mezz
UPC	191128862561

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	30V AC (RMS)/DC

Physical

Breakaway	No
Circuits (Loaded)	124
Circuits (maximum)	124
Color - Resin	Black
Durability (mating cycles max)	100

First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	Yes
Keying to Mating Part	None
Lock to Mating Part	No
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	BGA Solder
Material - Resin	High Temperature Thermoplastic
Net Weight	1.455/g
Number of Rows	5
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	1.50mm, 4.00mm
Plating min - Mating	0.762µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Yes
Stackable	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	20
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description Part Number	
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Mirror Mezz Hermaphroditic Connectors	202828
Connectors	

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